

**Maximum Ratings** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	60	V
Working Peak Reverse Voltage	$V_{RWM}$		
DC Blocking Voltage	$V_R$		
RMS Reverse Voltage	$V_{R(RMS)}$	42	V
Average Forward Current	$I_{F(AV)}$	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	$I_{FSM}$	50	A
Electrostatic Discharge	HBM	4000	V
Electrostatic Discharge	MM	400	V
Electrostatic Discharge	CDM	1	kV

**Thermal Characteristics**

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point (Cathode) (Note 6)	$R_{\theta JS}$	—	6	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient (Note 7)	$R_{\theta JA}$	125	—	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient (Note 8)	$R_{\theta JA}$	60	—	$^\circ\text{C/W}$
Typical Thermal Resistance to Case (Note 9)	$R_{\theta JC}$	—	18	$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to +150		$^\circ\text{C}$

**Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 10)	$V_{(BR)R}$	60	—	—	V	$I_R = 0.2\text{mA}$
Forward Voltage	$V_F$	—	—	0.50	V	$I_F = 1.0\text{A}$
Leakage Current (Note 10)	$I_R$	—	—	0.1	mA	$V_R = 60\text{V}, T_A = +25^\circ\text{C}$
Total Capacitance	$C_T$	—	67	—	pF	$V_R = 10\text{V}, f = 1.0\text{MHz}$
Switching Speed $t_{RR}$	$t_{RR}$	—	12	—	ns	$I_F=0.5\text{A}, I_R=1\text{A}, I_{RR}=0.25\text{A}$ (RG1)

- Notes:
- Theoretical  $R_{\theta JS}$  calculated from the top center of the die straight down to the PCB/cathode tab solder junction.
  - Device mounted on Polyimide substrate, 1" x 1" 2oz copper double-sided PC board with minimum recommended pad layout, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
  - Part mounted on 50.8mm\*50.8mm GETEK board with 25.4mm\*25.4mm copper pad, 25% anode, 75% cathode.  $T_A = +25^\circ\text{C}$
  - Part mounted on FR-4 board with 1.8mm X 2.5mm cathode and 1.8mm X 1.2mm anode, 1 oz. copper pads.  $T_A = +25^\circ\text{C}$
  - Short duration pulse test to minimize self-heating effect

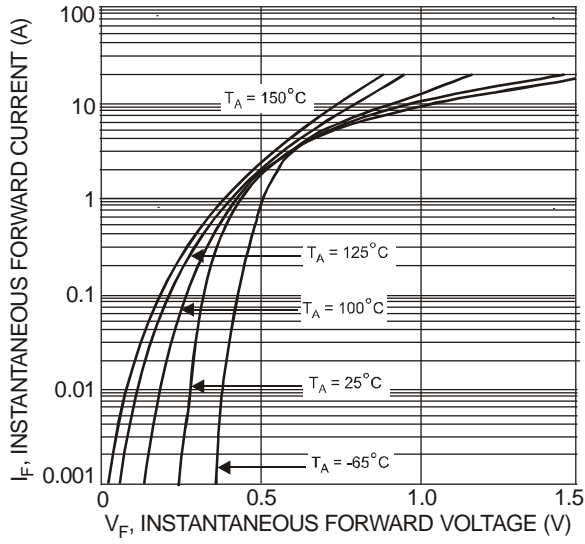


Fig. 1 Typical Forward Characteristics

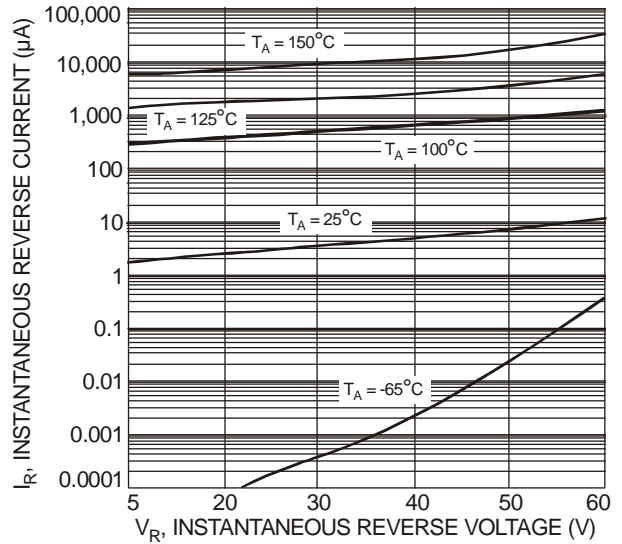


Fig. 2 Typical Reverse Characteristics

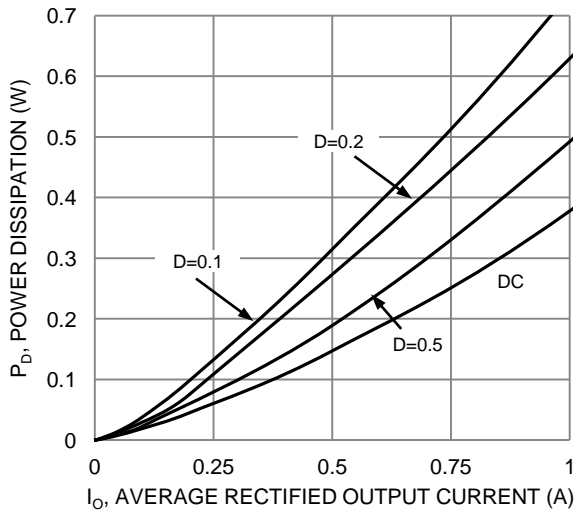


Fig. 3 Forward Power Dissipation  $T_J=125^\circ\text{C}$

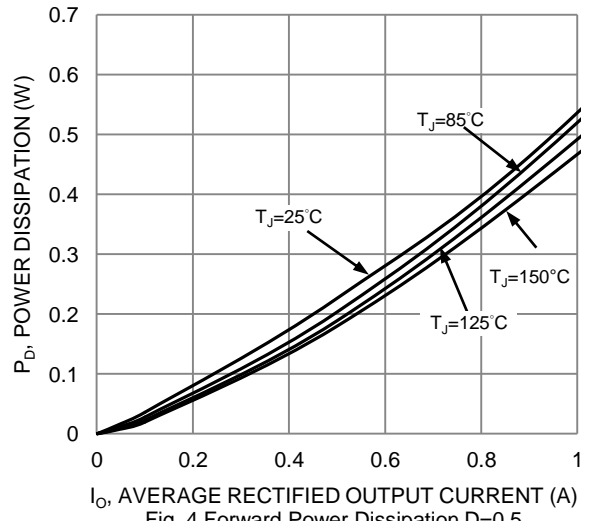


Fig. 4 Forward Power Dissipation  $D=0.5$

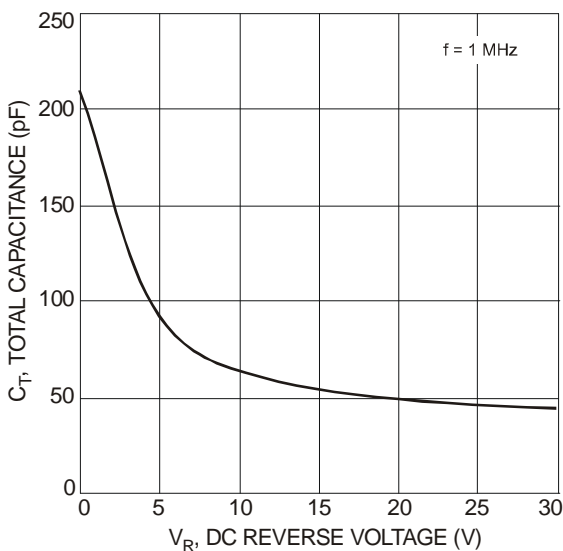


Fig. 5 Total Capacitance vs. Reverse Voltage

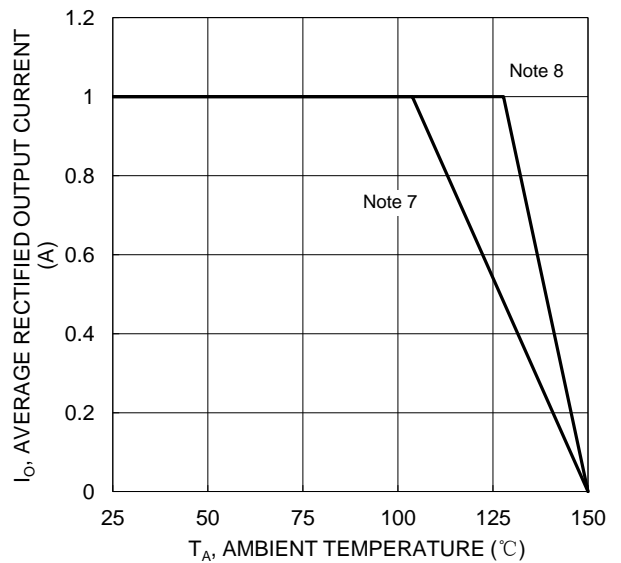


Fig. 6 DC Forward Current Derating

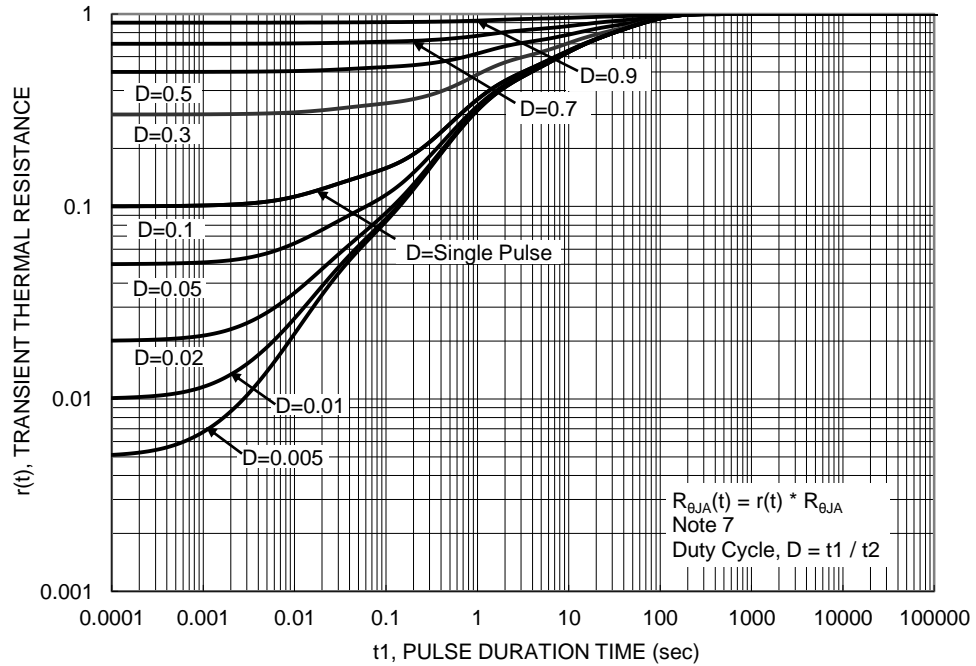
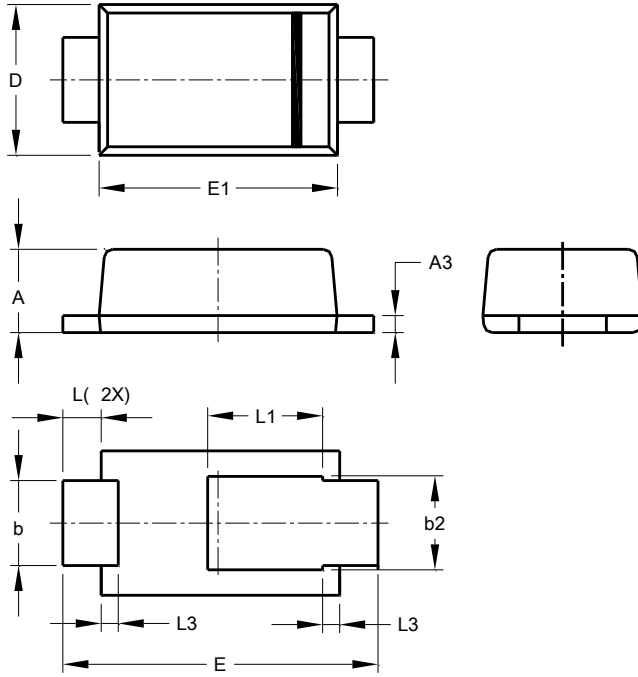


Fig. 7 Transient Thermal Resistance

**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**PowerDI123**

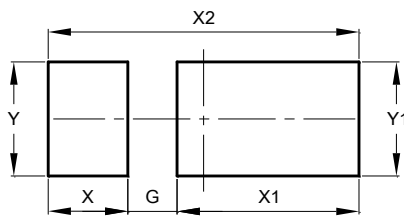


PowerDI123			
Dim	Min	Max	Typ
A	0.93	1.00	0.98
A3	0.15	0.25	0.20
b	0.85	1.25	1.00
b2	1.025	1.125	1.10
D	1.63	1.93	1.78
E	3.50	3.90	3.70
E1	2.60	3.00	2.80
L	0.40	0.50	0.45
L1	1.25	1.40	1.35
L3	0.125	0.275	0.20
All Dimensions in mm			

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**PowerDI123**



Dimensions	Value (in mm)
G	0.65
X	1.05
X1	2.40
X2	4.10
Y	1.50
Y1	1.50

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